

05-31-2002

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U.S. DEPARTMENT OF COMMERCE  
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Edward R. Moreth

5-29-02

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:



Assignment



Merger



Security Agreement



Change of Name



Other

Execution Date:

5-15-02

## 2. Name and address of receiving party(ies)

Name: Remco Technologies, Inc.

Internal Address:

Street Address: 3290 N.E. 33rd Street

City: Ft. Lauderdale State: FL Zip: 33338

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s) 6,146,677

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Melvin K. Silverman

Internal Address:

Street Address: 4901 N. Federal Highway

Suite 440

City: Ft. Lauderdale State: FL Zip: 33308

## 6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$ 40.00



Enclosed



Authorized to be charged to deposit account

## 8. Deposit account number:

FINANCE SECTION

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## 9. Signature.

MELVIN K. SILVERMAN

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231

05/31/2002 LMUELLER 00000001 6146677

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PATENT  
REEL: 12928 FRAME: 0433

## **ASSIGNMENT OF PATENT**

**WHEREAS**, I, R. Edward Moreth, who's office is located at 3290 N.E. 33<sup>rd</sup> St., Ft. Lauderdale, FL 33308, am a citizen of the United States and have invented certain new and useful improvements in a

### **High Efficiency Infrared Oven**

for which I have obtained a U.S. Letters Patent, namely, U.S. Patent No. 6,146,677, of even date herewith; and

**WHEREAS**, Remco Technologies, Inc., a Florida corporation, with its principle place of business located at 3290 N.E. 33<sup>rd</sup> St., Ft. Lauderdale, FL 33308, is desirous of obtaining the entire right, title, and interest in, to and under the said improvements and the said application:

**NOW, THEREFORE**, In consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, has sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto Remco Technologies, Inc., its successors, legal representatives and assigns the entire, right, title, and interest in, to and under said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, including the right to claim priority under the terms of the appropriate International Convention based upon said application for Letters Patent of the United States and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to Issue all Letters Patent for said improvements to Remco Technologies, Inc., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

**AND I HEREBY** covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and that I have not executed, and will not execute any agreement in conflict herewith.

**AND I HEREBY** further covenant and agree that I will communicate to said Remco Technologies, Inc., its successors, legal representative and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Remco Technologies, Inc., its

successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

**IN TESTIMONY WHEREOF**, I hereunto set my hand the day and year set opposite my signature.

5-15-02

DATE

  
R. EDWARD MORETH

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